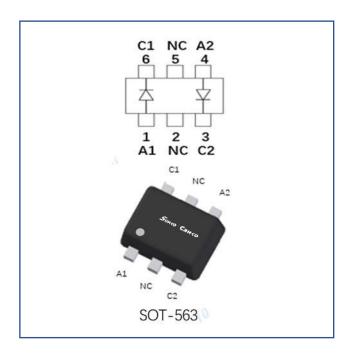


Switching Diode



Features

Moisture sensitivity level 1Reverse voltage: 100V

Average forward current : 200mA

Application

• High frequency rectifier

Signal switching

Mechanical data

• Package: SOT-563

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

■ Maximum Ratings (Ta=25°C Unless otherwise specified)

Item	Symbol	Unit	Value
Device marking code			KAL
Continuous reverse voltage	V _R	V	100
Forward continuous current	I _F	mA	200
Non-repetitive peak forward surge current @t=8.3ms half-sine wave			1.5
Non-repetitive surge peak forward current @ t=1ms square wave	I _{FSM}	A	1.6
Power dissipation	P _D	mW	150
Junction temperature	TJ	°C	-55 to +150
Storage temperature	T_{STG}	°C	-55 to +150



■ Electrical Characteristics (Ta=25°C Unless otherwise specified)

Item	Symbol	Unit	Conditions	Min	Тур	Max
Reverse voltage	V _R	٧	I _R =2.5uA	80		
Forward voltage	V _{F1}	V	I _F =5mA			0.720
	V _{F2}	V	I _F =10mA			0.855
	V _{F3}	V	I _F =50mA			1.0
	V _{F4}	V	I _F =150mA			1.25
Reverse current	I _{R1}	nA	V _R =20V			25
	I _{R2}	uA	V _R =70V			0.1
Junction capacitance	Cj	pF	f=1.0MHz, V _R =6.0V		3.5	
Reverse recovery time	Trr	ns	V _R =6.0V,I _F =5.0mA		4	

■ Thermal Characteristics

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	R ₀ J-A ⁽¹⁾	°C/W	833
Thermal resistance, junction-to-case	R ₀ J-C ⁽¹⁾	°C/W	667

Note:

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 25.4mm*25.4mm copper pad areas



■Characteristics

Fig 1: P_D-Ta Curve

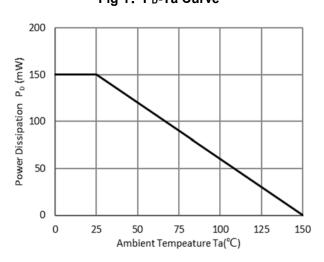


Fig 3: Typical Forward Characteristics

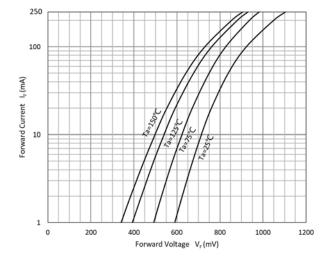


Fig 2: Capacitance Capability

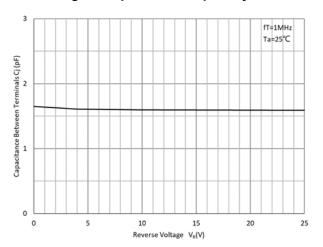
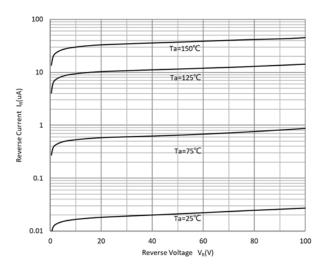


Fig 4: Typical Reverse Characteristics

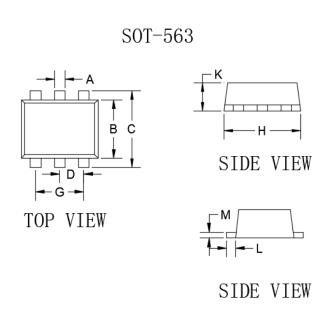




■Ordering Information

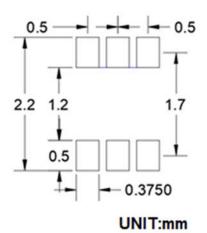
Preferred P/N	Packing code	Unit weight(g)	Minimum package(pcs)	Inner box quantity(pcs)	Outer carton quantity(pcs)	Delivery mode
MMBD4448V	F2	Approximate 0.0035	3000	30000	120000	7" reel

■ Outline Dimensions



DIMENSIONS					
DIM	INC	HES	ММ		
	MIN	MAX	MN	MAX	
А	0.006	0.011	0.150	0.300	
В	0.043	0.051	1.100	1.300	
С	0.059	0.067	1.500	1.700	
D	0.016	0.024	0.400	0.600	
G	0.035	0.043	0.900	1.100	
Н	0.059	0.067	1.500	1.700	
К	0.021	0.026	0.550	0.650	
L	0.004	0.011	0.100	0.300	
М	0.004	0.007	0.100	0.180	

■ Suggested Pad Layout





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